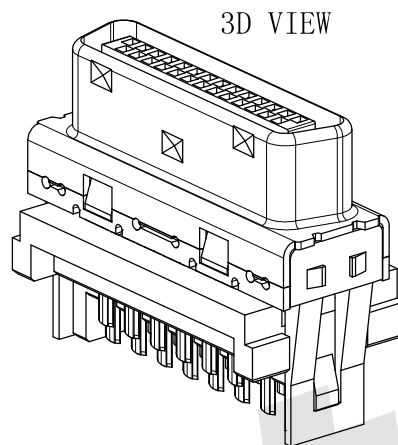
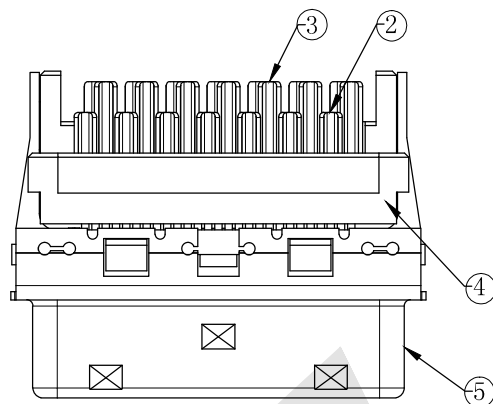
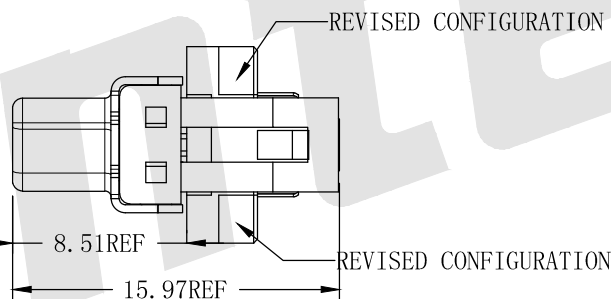
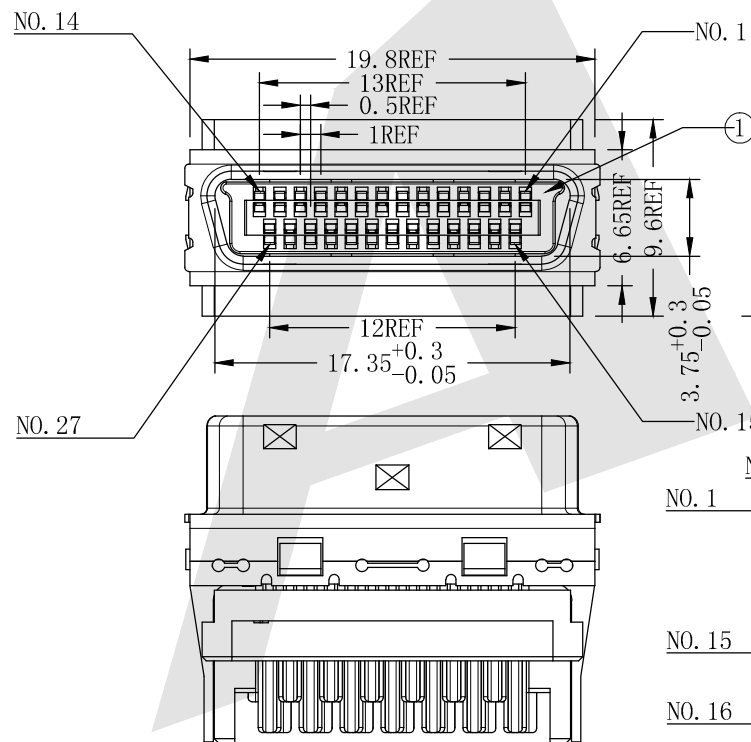


HSF



3D VIEW



REVISED CONFIGURATION

REVISED CONFIGURATION

MATERIAL:

1. Insulator:PBT+30%Glass Fiber(UL94V-0)
2. Cover:PBT+30% Glass Fiber(UL94V-0)
3. Contact:Brass Contact Plated:Glod Flash Over Nick
4. Shell:SPCC,Nickel Plated

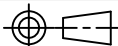
SPECIFICATION:

1. Curren Rating: 2 AMPS
2. Insulation Resistance:1000M Ω min. AT 500vDC
3. Dielectric Strength:500V For Five Second
4. Operation Temperature -55° - +105° C

Ordering Code:

HRS - M - V27 - G1
① ② ③ ④

- ① Series No: ④ Contact Plating:
② Contact Type: G0: Gold Flash Selective Plating
M:Male G1: 5u" Gold Selective Plating
③ Contact NO.: G2: 15u" Gold Selective Plating
V27=27P G3: 30u" Gold Selective Plating

MATERIAL		FINISH REMARKS
1	PLOYAMIDE	BLACK UL94V-0
2	PHOSPHOR	Contact Area:GOLD 0.125um MIN
3	BRONZE	Lead Area:GOLD 0.125um MIN Under Plating:Nickel 1um MIN
4	PLOYAMIDE	BLACK UL94V-0
5	STAINLESS STEEL	Nickel 1um MIN
Unless Otherwise specified tolerance		 ANTENK ELECTRONICS CO.,LTD Http://www.antenk.com E-mail:sales@antenk.com
X. ±0.35 X.XX: ±0.20 X.X: ±0.25 X.XXX: ±0.15		
SCALE: As Shown	UNIT: mm	
DRAW Wu Feng Rong	DATE 08/08/2020	TITLE: 1.0mm SCSI High Speed Transmission Small Interface Connector 27P Solder Contact Type
CHECK Bob Yang	DATE 08/08/2020	
		DRAWING NO: HRS-M-V27-G1
3rd ANGLE PROJECTION		PRODUCT NO: HRS-M-V27-G1

REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		